

PATENT ASSIGNMENT COVER SHEET

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 Stylesheet Version v1.2

EPAS ID: PAT2706298

SUBMISSION TYPE:	NEW ASSIGNMENT												
NATURE OF CONVEYANCE:	ASSIGNMENT												
CONVEYING PARTY DATA													
<table border="1"> <thead> <tr> <th>Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>KAZUNORI HAYASHI</td> <td>12/20/2013</td> </tr> <tr> <td>YOICHIRO SAKO</td> <td>01/04/2014</td> </tr> <tr> <td>TAKAYASU KON</td> <td>12/24/2013</td> </tr> <tr> <td>YASUNORI KAMADA</td> <td>01/06/2014</td> </tr> <tr> <td>TAKATOSHI NAKAMURA</td> <td>01/07/2014</td> </tr> </tbody> </table>		Name	Execution Date	KAZUNORI HAYASHI	12/20/2013	YOICHIRO SAKO	01/04/2014	TAKAYASU KON	12/24/2013	YASUNORI KAMADA	01/06/2014	TAKATOSHI NAKAMURA	01/07/2014
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RECEIVING PARTY DATA													
<table border="1"> <tr> <td>Name:</td> <td>SONY CORPORATION</td> </tr> <tr> <td>Street Address:</td> <td>1-7-1 KONAN, MINATO-KU</td> </tr> <tr> <td>City:</td> <td>TOKYO</td> </tr> <tr> <td>State/Country:</td> <td>JAPAN</td> </tr> <tr> <td>Postal Code:</td> <td>108-0075</td> </tr> </table>		Name:	SONY CORPORATION	Street Address:	1-7-1 KONAN, MINATO-KU	City:	TOKYO	State/Country:	JAPAN	Postal Code:	108-0075		
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PROPERTY NUMBERS Total: 1													
<table border="1"> <thead> <tr> <th>Property Type</th> <th>Number</th> </tr> </thead> <tbody> <tr> <td>Application Number:</td> <td>14168611</td> </tr> </tbody> </table>		Property Type	Number	Application Number:	14168611								
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Application Number:	14168611												
CORRESPONDENCE DATA													
Fax Number:	(858)942-3460												
Phone:	858-942-3460												
Email:	EVS@am.sony.com												
<i>Correspondence will be sent via US Mail when the email attempt is unsuccessful.</i>													
Correspondent Name:	SONY CORP OF AMERICA - EVS												
Address Line 1:	16530 VIA ESPRILLO												
Address Line 2:	MZ 7190												
Address Line 4:	SAN DIEGO, CALIFORNIA 92127												
ATTORNEY DOCKET NUMBER:	SP351167US00												
NAME OF SUBMITTER:	MEGUMI TADENUMA												

PATENT

Signature:	/Megumi Tadenuma/
Date:	01/30/2014
	This document serves as an Oath/Declaration (37 CFR 1.63).
Total Attachments: 5 source=SP351167US00_USFP#page1.tif source=SP351167US00_USFP#page2.tif source=SP351167US00_USFP#page3.tif source=SP351167US00_USFP#page4.tif source=SP351167US00_USFP#page5.tif	

DECLARATION (37 CFR 1.63) FOR UTILITY OR DESIGN APPLICATION USING AN
APPLICATION DATA SHEET (37 CFR 1.76) AND ASSIGNMENT FOR SINGLE ASSIGNEE

Title of
Invention

INFORMATION PROCESSING APPARATUS AND STORAGE MEDIUM

As the below named inventor, I hereby declare that:

This declaration
is directed to:



The attached application, or



United States application or PCT international application number _____

filed on _____

The above-identified application was made or authorized to be made by me.

I believe that I am the original inventor or an original joint inventor of a claimed invention in the application.

WHEREAS, SONY CORPORATION

1-7-1 KONAN, MINATO-KU, TOKYO, 108-0075, JAPAN

with offices at

(hereinafter referred to as ASSIGNEE), is desirous of

acquiring all interest in, to and under said invention, said application disclosing the invention and in, to and under any Letters Patent or similar legal protection which may be granted therefor in the United States and in any and all foreign countries;

NOW THEREFORE, in consideration of the sum of One Dollar (\$1.00), and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, I by these presents do hereby assign, sell and transfer unto said ASSIGNEE, its successors, assigns, and legal representatives, the entire right, title and interest in said invention, said application, including any divisions and continuations thereof, and in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted for said invention, and in and to any and all priority rights and/or convention rights under the International Convention for the Protection of Industrial Property, Inter-American Convention Relating to Patents, Designs and Industrial Models, and any other international agreements to which the United States of America adheres, and to any other benefits accruing or to accrue to me with respect to the filing of applications for patents or securing of patents in the United States and countries foreign thereto, and I hereby authorize and request the Commissioner of Patents to issue said United States Letters Patent to said ASSIGNEE, as the assignee of the whole right, title and interest thereof;

And I further agree to execute all necessary or desirable and lawful future documents, including assignments in favor of ASSIGNEE or its designee, as ASSIGNEE or its successors, assigns and legal representatives may from time-to-time present to me and without further remuneration, in order to perfect title in said invention, modifications, and improvements in said invention, applications and Letters Patent of the United States and countries foreign thereto;

And I further agree to properly execute and deliver and without further remuneration, such necessary or desirable and lawful papers for application for foreign patents, for filing subdivisions of said application for patent, and/or, for obtaining any reissue or renewals of any Letters Patent which may be granted for my aforesaid invention, as said ASSIGNEE thereof shall hereafter require and prepare at its own expense;

And I further agree that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said application, said invention and said Letters Patent and legal equivalents in foreign countries as may be known and accessible to me and will testify as to the same in any interference or litigation related thereto;

And I hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale.

I hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both.

LEGAL NAME OF INVENTOR

Inventor: KAZUNORI HAYASHI

Date: December 20, 2013

Signature: Kazunori Hayashi

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LEGAL NAME OF INVENTOR

Inventor: YOICHIRO SAKO

Date: January 4, 2014

Signature: Yoichiro Sako

January 4, 2014 Y.S.

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LEGAL NAME OF INVENTOR

Inventor: TAKAYASU KON

Date: December 27, 2013

Signature: Takayasu Kon

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LEGAL NAME OF INVENTOR

Inventor: YASUNORI KAMADA

Date: January 6, 2014

Signature: Yasunori Kamada

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LEGAL NAME OF INVENTOR

Inventor: TAKATOSHI NAKAMURA

Date: January 9, 2014

Signature: Takatoshi Nakamura